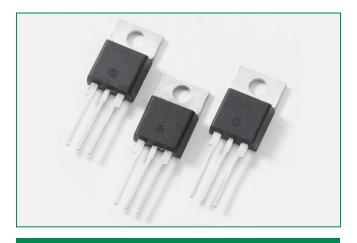


Qxx30xHx & Qxx35xHx Series







Agency Approval

Agency	Agency File Number
A	E71639*

^{* -} L Package and 30A only.

Description

The 30 Amp / 35 Amp bi-directional solid state switch series is designed for AC switching and phase control applications such as motor speed and temperature modulation controls, lighting controls, and static switching relays.

Standard type components normally operate in Quadrants I & III triggered from AC line.

Standard alternistor triac components operate with in-phase signals in Quadrants I or III and ONLY unipolar negative gate pulses for Quadrant II or III. The alternistor triac will not operate in Quadrant IV. These are used in circuit applications requiring a high dv/dt capability.

Features & Benefits

- RoHS Compliant
- Glass passivated junctions
- Voltage capability up to 800V
- Surge capability up to 350A at 60 Hz half cycle
- L-Package isolation rating of 2500V rms

Main Features

Symbol	Value	Unit
I _{T(RMS)}	30 or 35	А
V_{DRM}/V_{RRM}	400 or 600	V
Ι _{GT (Ω1)}	25 or 50	mA

Schematic Symbol



Applications

Excellent for AC switching and phase control applications such as heating, lighting, and motor speed controls.

Typical applications are AC solid-state switches, industrial power tools, exercise equipment, white goods and commercial appliances.

Alternistor Triacs (no snubber required) are used in applications with extremely inductive loads requiring highest commutation performance.

Internally constructed isolated packages are offered for ease of heat sinking with highest isolation voltage.

Additional Information



Datasheet



Resources



Samples



Absolute Maximum Ratings — Alternistor Triac (3 Quadrants)

Symbol	Param	Value	Unit		
	DMC on state surrent /full sine surrent)	Qxx35RH5/Qxx35NH5	T _C = 90°C	35	^
T(RMS)	RMS on-state current (full sine wave)	Qxx30LH5/Qxx30LH3	$T_{\rm C} = 50^{\circ}{\rm C}$	30	А
1	Non repetitive surge peak on-state current	f = 50 Hz	t = 20 ms	290	А
TSM	(full cycle, T _J initial = 25°C)	f = 60 Hz	t = 16.7 ms	350	A
l²t	I²t Value for fusing		$t_{p} = 8.3 \text{ ms}$	508	A ² s
di/dt	Critical rate of rise of on-state current ($I_g = 200$ mA with ≤ 0.1 µs rise time)	f = 120 Hz	T _J = 125°C	100	A/µs
I _{GTM}	Peak gate trigger current	t _p =20µs	T _J = 125°C	4	А
P _{G(AV)}	Average gate power dissipation $T_J = 125$ °C			0.5	W
T _{stg}	Storage temperature range			-40 to 125	°C
T_{J}	Operating junction temperature range			-25 to 125	°C

Electrical Characteristics (T_J = 25°C, unless otherwise specified) — Alternistor Triac (3 Quadrants)

Symbol	Test Conditions	Quadrant		Qxx35RH5 Qxx35NH5 Qxx30LH5	Qxx30LH3	Unit
I _{GT}	$V_D = 12V R_L = 30 \Omega$	1 – 11 – 111	MAX.	50	25	mA
$V_{\rm GT}$	$V_D = 12V R_L = 30 \Omega$	1 – 11 – 111	MAX.	2	2	V
$V_{\rm GD}$	$V_D = V_{DRM} R_L = 3.3 \text{ k}\Omega T_J = 125^{\circ}\text{C}$	1 – 11 – 111	MIN.	0.2	0.2	V
I _H	$I_{T} = 400 \text{mA}$		MAX.	75	40	mA
d\	$V_D = V_{DRM}$ Gate Open $T_J = 125$ °C	400V	MIN.	475	350	V/µs
dv/dt		600V		400	250	ν/μδ
(dv/dt)c	(di/dt)c = 18.9 A/ms $T_J = 125^{\circ}C$		MIN.	20	10	V/µs
	35A device $I_{g} = 2 \times I_{gT} \text{ PW} = 15 \mu \text{s} I_{T} = 49.5 \text{A(pk)}$		TYP.	3	3	110
t _{gt}	30A device $I_{G} = 2 \times I_{GT} \text{ PW} = 15 \mu \text{s} I_{T} = 42.4 \text{A(pk)}$		1117.	3	3	μs

Note: xx = voltage/10

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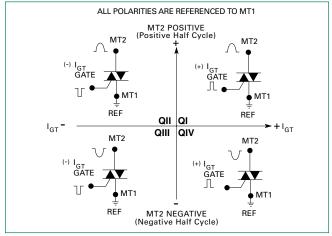


Static Chara	acteristics						
Symbol		Test Condit	tions			Value	Unit
V	35A device $I_{TM} = 49.5A t_p = 380 \mu s$				1.5		
V _{TM}	30A device $I_{TM} = 42.4A t_p = 380 \mu s$						V
I _{DBM}	V V V	Qxx35R/NH5	T _J = 25°C	400 - 600V	NAAV	10	μА
$V_{\rm D} = V_{\rm E}$	$V_{D} = V_{DRM} / V_{RRM}$	Qxx30LH5 Qxx30LH3	T _J = 125°C	400 - 600V	MAX.	2	mA

I nermal Kesistances							
Symbol		Parameter	Value	Unit			
D	R _{θ(J-C)} Junction to case (AC)	Qxx35RH5 / Qxx35NH5	0.85				
H _{θ(J-C)}		Qxx30LH5 / Qxx30LH3	2.30				
$R_{\theta(J-A)}$	Junction to ambient	Qxx35RH5	45	°C/W			
		Qxx30LH5 / Qxx30LH3	50	C/VV			

Note: xx = voltage/10

Figure 1: Definition of Quadrants



Note: Alternistors will not operate in QIV

Figure 2: Normalized DC Gate Trigger Current for All Quadrants vs. Junction Temperature

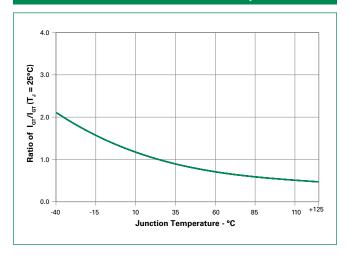




Figure 3: Normalized DC Holding Current vs. Junction Temperature

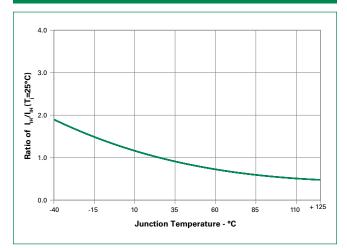
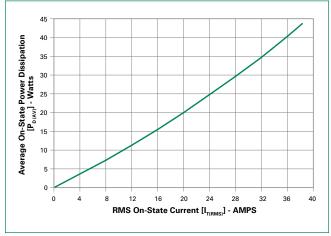
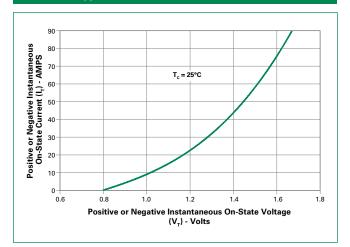


Figure 5: Power Dissipation (Typical) vs. RMS On-State Current



Note: xx = voltage

Figure 7: On-State Current vs. On-State Voltage (Typical)



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Figure 4: Normalized DC Gate Trigger Voltage for All Quadrants vs. Junction Temperature

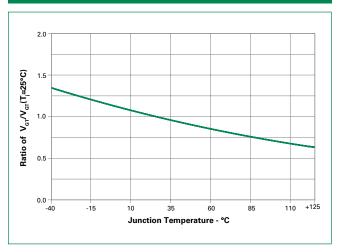
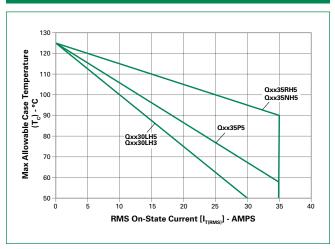
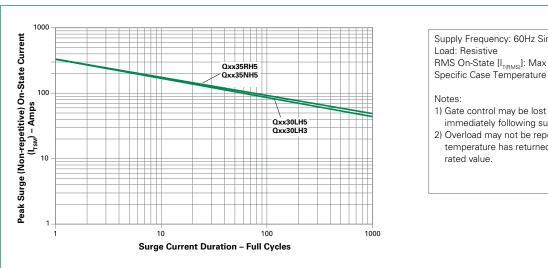


Figure 6: Maximum Allowable Case Temperature vs. On-State Current









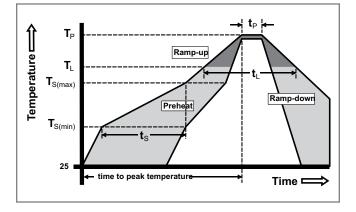
Supply Frequency: 60Hz Sinusoidal Load: Resistive RMS On-State $[I_{T(RMS)}]$: Max Rated Value at

- 1) Gate control may be lost during and immediately following surge current interval.
- 2) Overload may not be repeated until junction temperature has returned to steady-state rated value.

Note: xx = voltage

Soldering Parameters

Reflow Condition		Pb – Free assembly	
	-Temperature Min (T _{s(min)})	150°C	
Pre Heat	-Temperature Max (T _{s(max)})	200°C	
	-Time (min to max) (t _s)	60 – 180 secs	
Average ramp up rate (Liquidus Temp) (T _L) to peak		5°C/second max	
T _{S(max)} to T _L	- Ramp-up Rate	5°C/second max	
Reflow	-Temperature (T _L) (Liquidus)	217°C	
nellow	-Time (min to max) (t _s)	60 – 150 seconds	
PeakTemp	erature (T _P)	260 ^{+0/-5} °C	
Time within 5°C of actual peak Temperature (t _p)		20 - 40 seconds	
Ramp-down Rate		5°C/second max	
Time 25°C to peak Temperature (T _P)		8 minutes Max.	
Do not exc	ceed	280°C	





Physical Specifications

Terminal Finish	100% Matte Tin-plated.
Body Material	UL Recognized compound meeting flammability rating V-0
Terminal Material	Copper Alloy

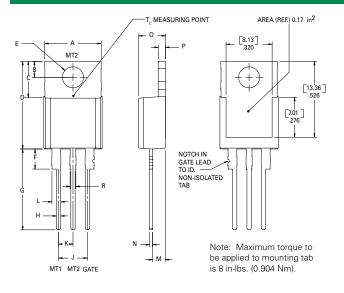
Design Considerations

Careful selection of the correct component for the application's operating parameters and environment will go a long way toward extending the operating life of the Thyristor. Good design practice should limit the maximum continuous current through the main terminals to 75% of the component rating. Other ways to ensure long life for a power discrete semiconductor are proper heat sinking and selection of voltage ratings for worst case conditions. Overheating, overvoltage (including dv/dt), and surge currents are the main killers of semiconductors. Correct mounting, soldering, and forming of the leads also help protect against component damage.

Environmental Specifications

Test	Specifications and Conditions
AC Blocking	MIL-STD-750, M-1040, Cond A Applied Peak AC voltage @ 125°C for 1008 hours
Temperature Cycling	MIL-STD-750, M-1051, 100 cycles; -40°C to +150°C; 15-min dwell-time
Temperature/ Humidity	EIA / JEDEC, JESD22-A101 1008 hours; 320V - DC: 85°C; 85% rel humidity
High Temp Storage	MIL-STD-750, M-1031, 1008 hours; 150°C
Low-Temp Storage	1008 hours; -40°C
Thermal Shock	MIL-STD-750, M-1056 10 cycles; 0°C to 100°C; 5-min dwell- time at each temperature; 10 sec (max) transfer time between temperature
Autoclave	EIA / JEDEC, JESD22-A102 168 hours (121°C at 2 ATMs) and 100% R/H
Resistance to Solder Heat	MIL-STD-750 Method 2031
Solderability	ANSI/J-STD-002, category 3, Test A
Lead Bend	MIL-STD-750, M-2036 Cond E

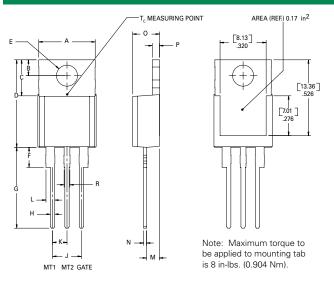
Dimensions — TO-220AB (R-Package) — Non-Isolated Mounting Tab Common with Center Lead



Dimension	Inc	hes	Millin	neters
Dimension	Min	Max	Min	Max
А	0.380	0.420	9.65	10.67
В	0.105	0.115	2.67	2.92
С	0.230	0.250	5.84	6.35
D	0.590	0.620	14.99	15.75
Е	0.142	0.147	3.61	3.73
F	0.110	0.130	2.79	3.30
G	0.540	0.575	13.72	14.61
Н	0.025	0.035	0.64	0.89
J	0.195	0.205	4.95	5.21
K	0.095	0.105	2.41	2.67
L	0.060	0.075	1.52	1.91
М	0.085	0.095	2.16	2.41
N	0.018	0.024	0.46	0.61
0	0.178	0.188	4.52	4.78
Р	0.045	0.060	1.14	1.52
R	0.038	0.048	0.97	1.22

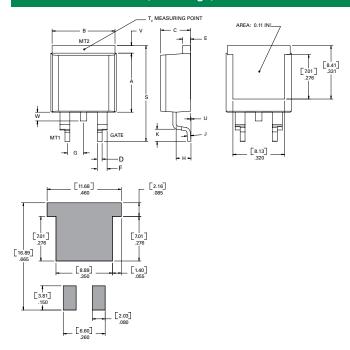


Dimensions — TO-220AB (L-Package) — Isolated Mounting Tab



Dimension	Inc	hes	Millin	neters
Dimension	Min	Max	Min	Max
А	0.380	0.420	9.65	10.67
В	0.105	0.115	2.67	2.92
С	0.230	0.250	5.84	6.35
D	0.590	0.620	14.99	15.75
Е	0.142	0.147	3.61	3.73
F	0.110	0.130	2.79	3.30
G	0.540	0.575	13.72	14.61
Н	0.025	0.035	0.64	0.89
J	0.195	0.205	4.95	5.21
K	0.095	0.105	2.41	2.67
L	0.060	0.075	1.52	1.91
М	0.085	0.095	2.16	2.41
N	0.018	0.024	0.46	0.61
0	0.178	0.188	4.52	4.78
Р	0.045	0.060	1.14	1.52
R	0.038	0.048	0.97	1.22

Dimensions — TO-263 (N-Package) — D² Pak Surface Mount



Dimension	Inc	hes	Millin	neters
Dimension	Min	Max	Min	Max
А	0.360	0.370	9.14	9.40
В	0.380	0.420	9.65	10.67
С	0.178	0.188	4.52	4.78
D	0.025	0.035	0.64	0.89
Е	0.045	0.060	1.14	1.52
F	0.060	0.075	1.52	1.91
G	0.095	0.105	2.41	2.67
Н	0.092	0.102	2.34	2.59
J	0.018	0.024	0.46	0.61
K	0.090	0.110	2.29	2.79
S	0.590	0.625	14.99	15.88
V	0.035	0.045	0.89	1.14
U	0.002	0.010	0.05	0.25
W	0.040	0.070	1.016	1.78



Product Selector

Part Number	Voltage			Gate Sensitivity Quadrants			Time	Dookowa
	400V	600V	800V	1 – 11 – 111	IV	T(RMS)	Type	Package
Qxx35RH5	Х	Х		50 mA		35A	Alternistor Triac	TO-220R
Qxx35NH5	Х	Х		50 mA		35A	Alternistor Triac	TO-263 D ² -PAK
Qxx30LH5	Х	Х		50 mA		30A	Alternistor Triac	TO-220L
Qxx30LH3	Х	Х		25 mA		30A	Alternistor Triac	TO-220L

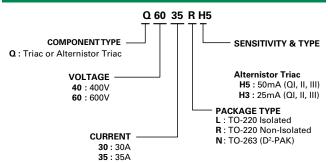
Note: xx = Voltage/10

Packing Options

Part Number	Marking	Weight	Packing Mode	Base Quantity
Qxx35RH5TP	Qxx35RH5	2.20 g	Tube	500 (50 per tube)
Qxx35NH5TP	Qxx35NH5	1.60 g	Tube	500 (50 per tube)
Qxx35NH5RP	Qxx35NH5	1.60 g	Embossed Carrier	500
Qxx30LH5TP	Qxx30LH5	2.20 g	Tube	500 (50 per tube)
Qxx30LH3TP	Qxx30LH3	2.20 g	Tube	500 (50 per tube)

xx = voltage/10

Part Numbering System



Part Marking System

TO-220 AB - (L and R Package) TO-263 AB - (N Package)



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TO-263 Embossed Carrier Reel Pack (RP) Specifications

Meets all EIA-481-2 Standards

